



### B340LA/B

### 3.0A LOW VF SCHOTTKY BARRIER RECTIFIER

### **Features**

- Very Low Forward Voltage Drop
- Guard Ring Die Construction for Transient Protection
- Ideally Suited for Automated Assembly
- Low Power Loss, High Efficiency
- Surge Overload Rating to 70A Peak
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

### **Mechanical Data**

- Case: SMA/SMB
- Case Material: Molded Plastic; UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Lead Free Plating (Matte Tin Finish). Solderable per MIL-STD-202, Method 208
- Polarity: Cathode Band or Cathode Notch
- Weight: SMA 0.064 grams (Approximate)

SMB 0.093 grams (Approximate)

#### SMA/SMB





Top View

**Bottom View** 

### Ordering Information (Note 4)

| Part Number | Case | Packaging         |
|-------------|------|-------------------|
| B340LA-13-F | SMA  | 5,000/Tape & Reel |
| B340LB-13-F | SMB  | 3,000/Tape & Reel |

Notes:

- 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.
- 2. See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

WW = Week Code (01 to 53)

4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

## **Marking Information**

#### SMA/SMB





## **Maximum Ratings** (@ $T_A = +25$ °C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitive load, derate current by 20%.

| Characteristic   | Symbol   | Value | Unit |
|--|--|-------|------|
| Peak Repetitive Reverse Voltage<br>Working Peak Reverse Voltage<br>DC Blocking Voltage       | V <sub>RRM</sub><br>V <sub>RWM</sub><br>V <sub>R</sub> | 40    | ٧    |
| Average Rectified Output Current (Note 5) $T_T = +90^{\circ}C$                               | lo   | 3.0   | Α    |
| Non-Repetitive Peak Forward Surge Current, Single Sine-Wave Superimposed on Rated Load, 60Hz | I <sub>FSM</sub>                                       | 70    | А    |

### **Thermal Characteristics**

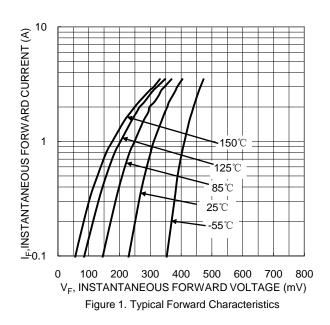
| Characteristic                          | Symbol                            | Value       | Unit |
|---|-----------------------------------|-------------|------|
| Operating and Storage Temperature Range | T <sub>J</sub> , T <sub>STG</sub> | -55 to +150 | °C   |

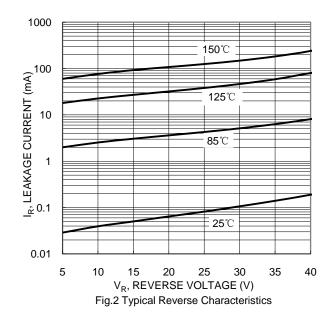
## **Electrical Characteristics** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

| Characteristic                           | Symbol          | Min | Тур   | Max   | Unit | Conditions               |
|--|-----------------|-----|-------|-------|------|--------------------------|
| Reverse Breakdown Voltage (Note 6)       | $V_{(BR)R}$     | 40  | _     | _     | V    | $I_R = 2.0 \text{mA}$    |
| Forward Voltage Drop                     | \/_             | _   | 0.310 | 0.350 | V    | I <sub>F</sub> = 1.0A    |
| l olward voltage brop                    | V <sub>F</sub>  | _   | —     | 0.450 | V    | $I_F = 3.0A$             |
|  |                 |     | _     | 150   | μΑ   | V <sub>R</sub> = 15V     |
| Leakage Current (Note 6)                 | $I_R$           | _   | _     | 1.0   | mA   | $V_R = 20V$              |
|  |                 |     | _     | 2.0   | ш    | $V_R = 40V$              |
| Total Capacitance                        | Ст              | _   | 180   | _     | рF   | $f = 1MHz, V_R = 4.0VDC$ |
| Thermal Resistance, Junction to Terminal | $R_{\theta JT}$ | _   | 35    | _     | °C/W | _                        |

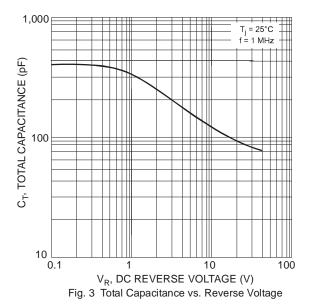
Notes:

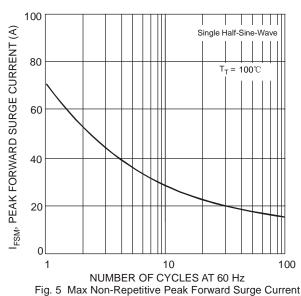
- $5.\ Device\ mounted\ on\ FR-4\ substrate,\ 0.4"*0.5",\ 2oz,\ single-sided,\ PC\ boards\ with\ 0.2"*0.25"\ copper\ pad.$
- 6. Short duration pulse test used to minimize self-heating effect.

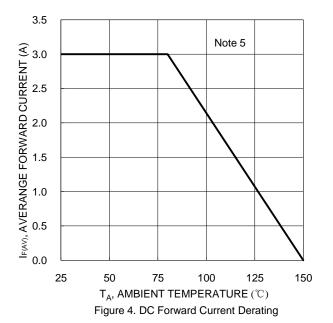










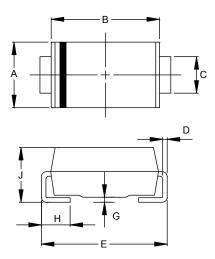




## **Package Outline Dimensions**

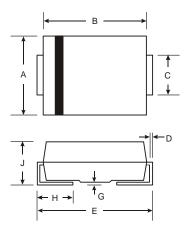
Please see http://www.diodes.com/package-outlines.html for the latest version.

### 1) Package Type:SMA



| SMA                  |      |      |  |
|----------------------|------|------|--|
| Dim                  | Min  | Max  |  |
| Α                    | 2.29 | 2.92 |  |
| В                    | 4.00 | 4.60 |  |
| С                    | 1.27 | 1.63 |  |
| D                    | 0.15 | 0.31 |  |
| Е                    | 4.80 | 5.59 |  |
| G                    | 0.05 | 0.20 |  |
| Н                    | 0.76 | 1.52 |  |
| J                    | 1.96 | 2.40 |  |
| All Dimensions in mm |      |      |  |

### 2) Package Type:SMB



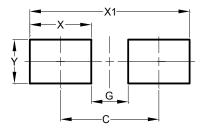
| SMB                  |      |      |
|----------------------|------|------|
| Dim                  | Min  | Max  |
| Α                    | 3.30 | 3.94 |
| В                    | 4.06 | 4.57 |
| C                    | 1.96 | 2.21 |
| D                    | 0.15 | 0.31 |
| Е                    | 5.00 | 5.59 |
| G                    | 0.05 | 0.20 |
| Н                    | 0.76 | 1.52 |
| 7                    | 2.00 | 2.50 |
| All Dimensions in mm |      |      |



## **Suggested Pad Layout**

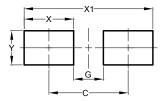
Please see http://www.diodes.com/package-outlines.html for the latest version.

### 1) Package Type:SMA



| Dimensions | Value<br>(in mm) |
|------------|------------------|
| C          | 4.00             |
| G          | 1.50             |
| Х          | 2.50             |
| X1         | 6.50             |
| Υ          | 1.70             |

### 2) Package Type:SMB



| Dimensions | Value (in mm) |
|------------|---------------|
| С          | 4.30          |
| G          | 1.80          |
| Х          | 2.50          |
| X1         | 6.80          |
| Υ          | 2.30          |



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